



Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at
www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

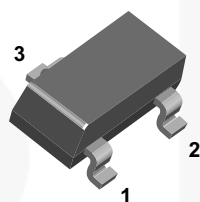
ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.



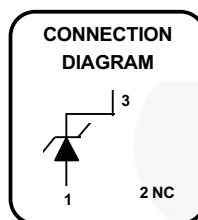
November 2015

BZX84C3V3 - BZX84C33 Zeners

Tolerance: C = 5%



SOT-23



Absolute Maximum Ratings^{(1),(2)}

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter		Value	Unit
I_{FRM}	Repetitive Peak Forward Current		250	mA
I_{ZRM}	Repetitive Peak Working Current		250	mA
P_D	Power Dissipation	Referencing $R_{\theta JA}$, $T_A = 25^\circ\text{C}$	250	mW
		Referencing ψ_{JL} , $T_L = 25^\circ\text{C}$	550	
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance ⁽³⁾		465	$^\circ\text{C/W}$
ψ_{JL}	Junction-to-Lead Thermal Characteristics (with reference to Cathode)		220	$^\circ\text{C/W}$
T_{STG}	Storage Temperature Range		-55 to +150	$^\circ\text{C}$
T_J	Operating Junction Temperature		-55 to +150	$^\circ\text{C}$

Notes:

1. These ratings are based on a maximum junction temperature of 150°C .
2. These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty-cycle operations.
3. Device mounted on FR-4 PCB, board size = 76.2 mm x 114.3 mm

Electrical Characteristics

Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Device	Mark	$I_Z = 5.0\text{ mA}$			$I_Z = 1.0\text{ mA}$			$I_Z = 20\text{ mA}$		
		$V_Z\text{ (V)}$		$Z_Z\text{ (}\Omega\text{)}$	$V_Z\text{ (V)}$		$Z_Z\text{ (}\Omega\text{)}$	$V_Z\text{ (V)}$		$Z_Z\text{ (}\Omega\text{)}$
		Min.	Max.		Min.	Max.		Min.	Max.	
BZX84C3V3	Z14	3.1	3.5	95	2.3	2.9	600	3.6	4.2	40
BZX84C3V6	Z15	3.4	3.8	90	2.7	3.3	600	3.9	4.5	40
BZX84C3V9	Z16	3.7	4.1	90	2.9	3.5	600	4.1	4.7	30
BZX84C4V3	Z17	4.0	4.6	90	3.3	4.0	600	4.4	5.1	30
BZX84C4V7	Z1	4.4	5.0	80	3.7	4.7	500	4.5	5.4	15
BZX84C5V1	Z2	4.8	5.4	60	4.2	5.3	480	5.0	5.9	15
BZX84C5V6	Z3	5.2	6.0	40	4.8	6.0	400	5.2	6.3	10
BZX84C6V2	Z4	5.8	6.6	10	5.6	6.6	150	5.8	6.8	6
BZX84C6V8	Z5	6.4	7.2	15	6.3	7.2	80	6.4	7.4	6
BZX84C7V5	Z6	7.0	7.9	15	6.9	7.9	80	7.0	8.0	6
BZX84C8V2	Z7	7.7	8.7	15	7.6	8.7	80	7.7	8.8	6
BZX84C9V1	Z8	8.5	9.6	15	8.4	9.6	100	8.5	9.7	8
BZX84C10	Z9	9.4	10.6	20	9.3	10.6	150	9.4	10.7	10
BZX84C11	Y1	10.4	11.6	20	10.2	11.6	150	10.4	11.8	10
BZX84C12	Y2	11.4	12.7	25	11.2	12.7	150	11.4	12.9	10
BZX84C13	Y3	12.4	14.1	30	12.3	14.0	170	12.5	14.2	15
BZX84C15	Y4	13.8	15.6	30	13.7	15.5	200	13.9	15.7	20
BZX84C16	Y5	15.3	17.1	40	15.2	17.0	200	15.4	17.2	20
BZX84C18	Y6	16.8	19.1	45	16.7	19.0	225	16.9	19.2	20
BZX84C20	Y7	18.8	21.2	55	18.7	21.1	225	18.9	21.4	20
BZX84C22	Y8	20.8	23.3	55	20.7	23.2	250	20.9	23.4	25
BZX84C24	Y9	22.8	25.6	70	22.7	25.5	250	22.9	25.7	25
BZX84C27	Y10	25.1	28.9	80	25.0	28.9	300	25.2	29.3	45
BZX84C30	Y11	28.0	32.0	80	27.8	32.0	300	28.1	32.4	50
BZX84C33	Y12	31.0	35.0	80	30.8	35.0	325	31.1	35.4	55

V_F Forward Voltage = 0.9 V Maximum at $I_F = 10\text{ mA}$ for all BZX84 series

Electrical Characteristics (Continued)Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Device	V_R (V)	I_R (μA)	Cap ⁽⁴⁾ (pF)	D_{VZ} / D_t at 5.0 mA (mV/k)	
				Min.	Max.
BZX84C3V3	1.0	5.0	450	-3.5	0.0
BZX84C3V6	1.0	5.0	450	-3.5	0.0
BZX84C3V9	1.0	5.0	450	-3.5	0.0
BZX84C4V3	1.0	5.0	450	-3.5	0.0
BZX84C4V7	2.0	3	260	-3.5	0.2
BZX84C5V1	2.0	2	225	-2.7	1.2
BZX84C5V6	2.0	1	200	-2.0	2.5
BZX84C6V2	4.0	3	185	0.4	3.7
BZX84C6V8	4.0	2	155	1.2	4.5
BZX84C7V5	5.0	1	140	2.5	5.3
BZX84C8V2	5.0	0.7	135	3.2	6.2
BZX84C9V1	6.0	0.5	130	3.8	7.0
BZX84C10	7.0	0.2	130	4.5	8.0
BZX84C11	8.0	0.1	130	5.4	9.0
BZX84C12	8.0	0.1	130	6.0	10
BZX84C13	8.0	0.1	120	7.0	11
BZX84C15	10.5	0.05	110	9.2	13
BZX84C16	11.2	0.05	105	10.4	14
BZX84C18	12.6	0.05	100	12.4	16
BZX84C20	14	0.05	85	14.4	18
BZX84C22	15.4	0.05	85	16.4	20
BZX84C24	16.8	0.05	80	18.4	22
BZX84C27	18.9	0.05	70	21.4	25.3
BZX84C30	21	0.05	70	24.4	29.4
BZX84C33	23.1	0.05	70	27.4	33.4

Note:4. Capacitance at $V_R = 0.0$ V, $f = 1.0$ MHz.

Typical Performance Characteristics

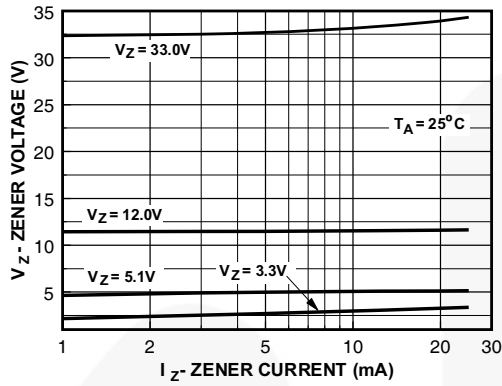


Figure 1. Zener Current vs. Zener Voltage

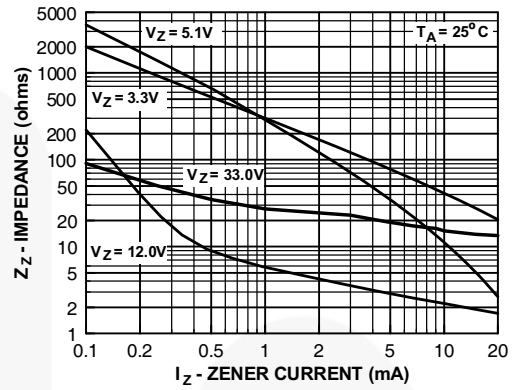


Figure 2. Zener Current vs. Zener Impedance

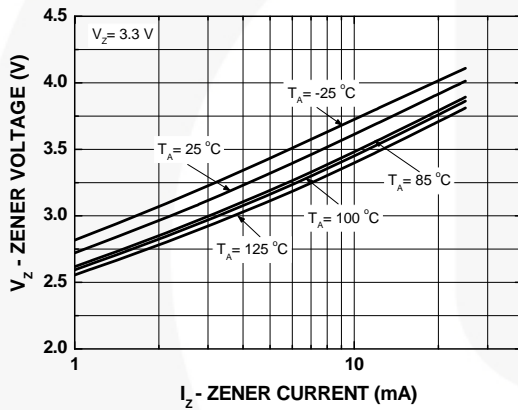


Figure 3. 3.3 V Zener Voltage vs. Temperature

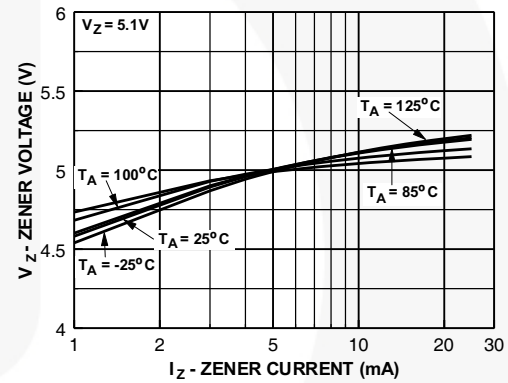


Figure 4. 5.1 V Zener Voltage vs. Temperature

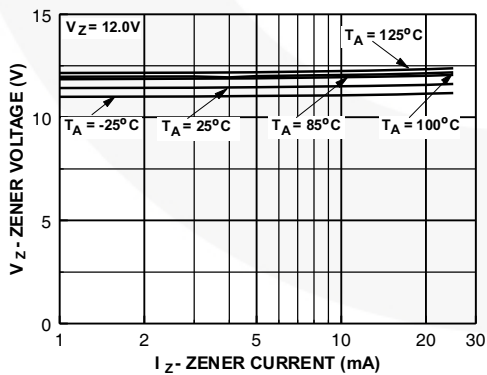


Figure 5. 12 V Zener Voltage vs. Zener Temperature

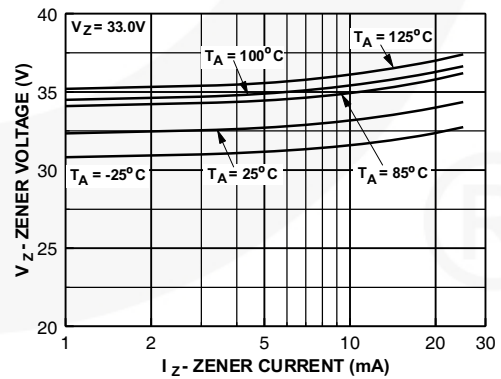
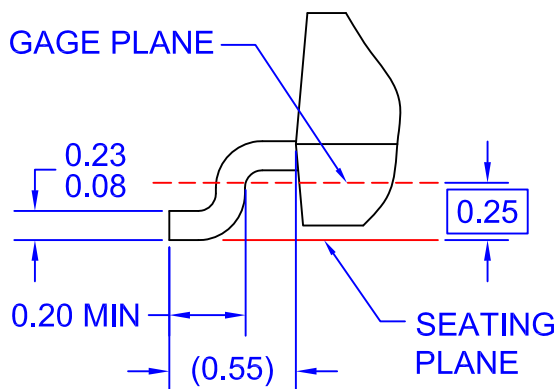
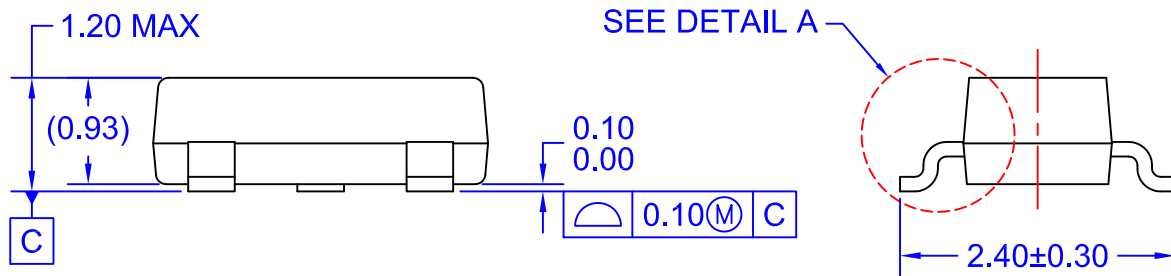
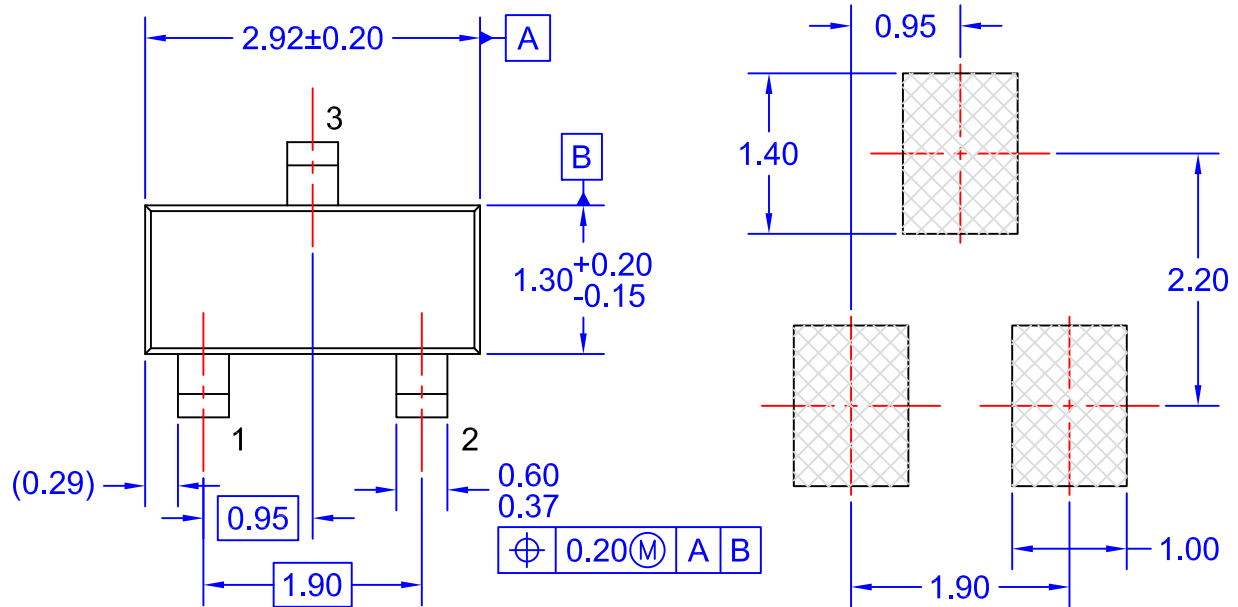


Figure 6. 33 V Zener Voltage vs. Zener Temperature



DETAIL A
SCALE: 2X

NOTES: UNLESS OTHERWISE SPECIFIED

- A) REFERENCE JEDEC REGISTRATION TO-236, VARIATION AB, ISSUE H.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS ARE INCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.
- D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M - 2009.
- E) DRAWING FILE NAME: MA03DREV12



ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free
USA/Canada

Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910

Japan Customer Focus Center
Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: <http://www.onsemi.com/orderlit>

For additional information, please contact your local
Sales Representative

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[onsemi:](#)

[BZX84C20](#)